

P-Channel 60 V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|-------------------------------------|---------------------------------|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^c | | |
| - 60 | 0.0093 at V _{GS} = - 10 V | - 90 | | |
| - 60 | 0.0118 at V _{GS} = - 4.5 V | - 90 | | |

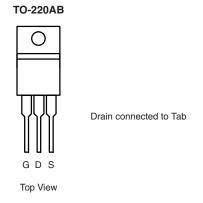
FEATURES

- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

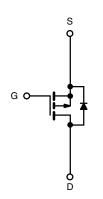


APPLICATIONS

• DC/DC Primary Switch



Ordering Information: SUP90P06-09L-E3 (Lead (Pb)-free)



P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | |
|--|-------------------------|-----------------------------------|------------------|----|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage | V _{DS} | - 60 | V | | |
| Gate-Source Voltage | V _{GS} | ± 20 | V | | |
| Continuous Dusin Comment /T 175 9000 | T _C = 25 °C | L | - 90 | | |
| Continuous Drain Current (T _J = 175 °C) ^C | T _C = 125 °C | l _D | - 67 | _ | |
| Pulsed Drain Current | I _{DM} | - 200 | Α | | |
| Avalanche Current | L = 0.1 mH | I _{AS} | - 65 | | |
| Single Pulse Avalanche Energy ^a | L = 0.1 IIII | E _{AS} | 211 | mJ | |
| Power Dissipation | T _C = 25 °C | P _D | 250 ^b | W | |
| rower Dissipation | T _A = 25 °C | ' D | 2.4 | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|------------------------------|-------------------|-------|---------|--|--|
| Parameter | Symbol | Limit | Unit | | |
| Junction-to-Ambient Free Air | R _{thJA} | 62 | °C/W | | |
| Junction-to-Case | R _{thJC} | 0.6 | - 10/00 | | |

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. Limited by package.

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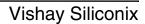


| SPECIFICATIONS (T _J = 25 | | | | _ | | | |
|--|----------------------|---|-------|--------|--------|------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0 \text{ V, } I_D = -250 \mu\text{A}$ | - 60 | | | ٧ | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1 | | - 3 | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | V _{DS} = - 60 V, V _{GS} = 0 V | | | - 1 | μΑ | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$ | | | - 50 | | |
| | | V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 175 °C | | | - 250 | | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = - 5 V, V _{GS} = - 10 V | - 120 | | | Α | |
| | | V _{GS} = - 10 V, I _D = - 30 A | | 0.0074 | 0.0093 | | |
| | | V _{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C | | | 0.0150 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -10 \text{ V}, I_D = -30 \text{ A}, T_J = 175 ^{\circ}\text{C}$ | | | 0.0190 | | |
| | | V _{GS} = - 4.5 V, I _D = - 20 A | | 0.0094 | 0.0118 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 30 A | 20 | | | S | |
| Dynamic ^b | • | | | • | | | |
| Input Capacitance | C _{iss} | | | 9200 | | pF | |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, V _{DS} = - 25 V, f = 1 MHz | | 975 | | | |
| Reverse Transfer Capacitance | C _{rss} | 1 | | 760 | | | |
| Total Gate Charge ^c | Q_g | | | 160 | 240 | | |
| Gate-Source Charge ^c | Q _{gs} | V _{DS} = - 30 V, V _{GS} = - 10 V, I _D = - 90 A | | 40 | | nC | |
| Gate-Drain Charge ^c | Q _{gd} | 1 | | 36 | | | |
| Gate Resistance | R _g | f = 1.0 MHz | | 3 | | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 20 | 30 | | |
| Rise Time ^c | t _r | $V_{DD} = -30 \text{ V}, R_{L} = 0.33 \Omega$ | | 190 | 285 | ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong$ - 90 A, V_{GEN} = - 10 V, R_g = 2.5 Ω | | 140 | 210 | | |
| Fall Time ^c | t _f | 1 | | 300 | 450 | | |
| Source-Drain Diode Ratings and Characteristics (T _C = 25 °C) ^b | | | | | | | |
| Continuous Current | I _S | | | | - 90 | _ | |
| Pulsed Current | I _{SM} | | | | - 200 | Α | |
| Forward Voltage ^a | V _{SD} | I _F = - 50 A, V _{GS} = 0 V | | - 1.0 | - 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 60 | 90 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = - 50 A, dI/dt = 100 A/μs | | - 3 | - 4.5 | Α | |
| Reverse Recovery Charge | Q _{rr} | † | | 0.09 | 0.2 | μС | |

Notes:

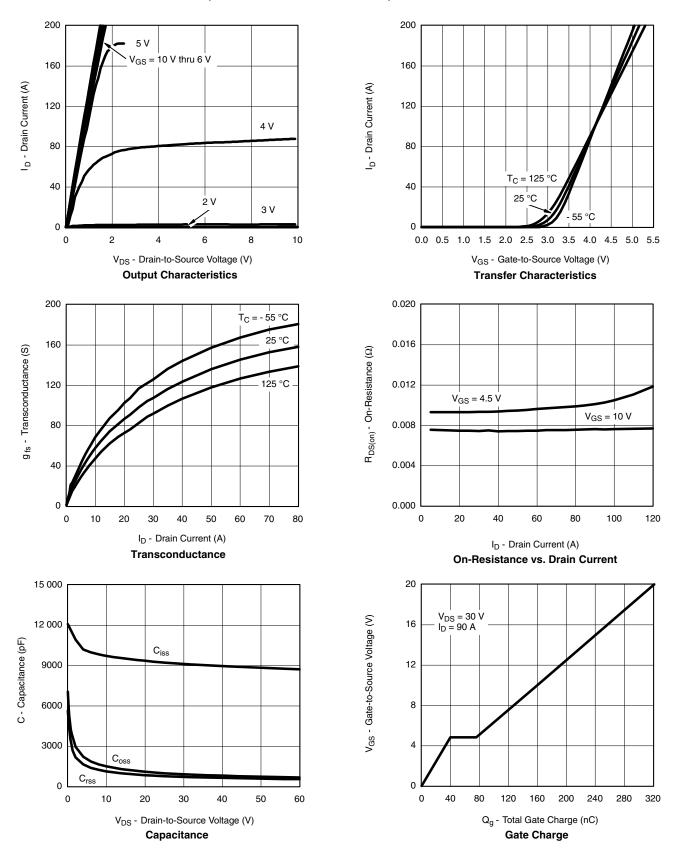
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





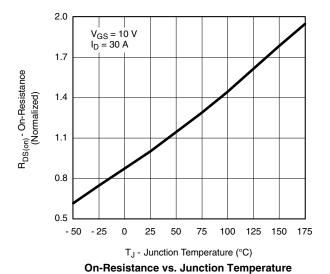
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

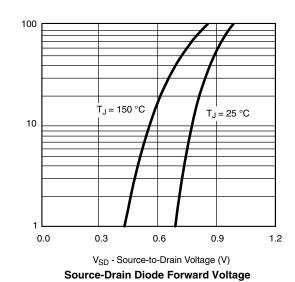


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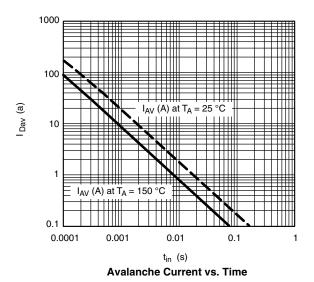
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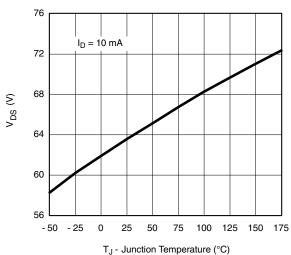
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Is - Source Current (A)



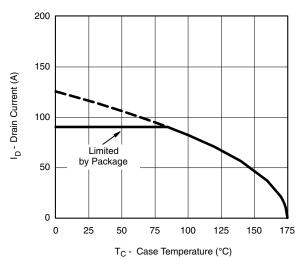


Drain Source Breakdown vs.
Junction Temperature

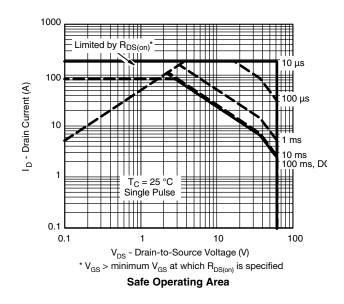


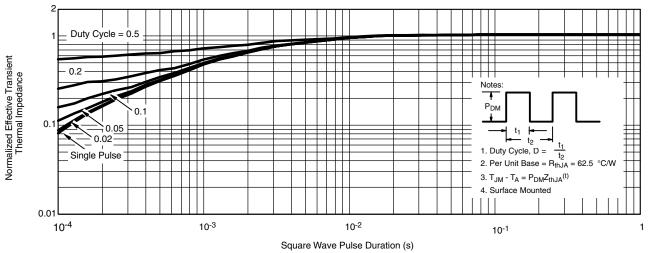


THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature





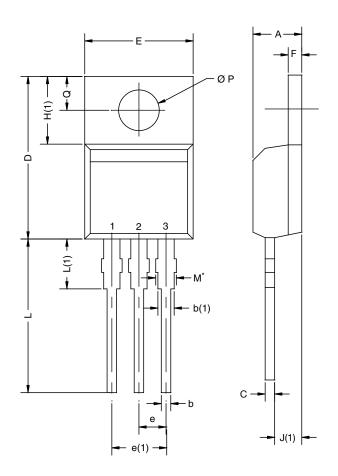
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppq?73010.



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TO-220AB



| | MILLIMETERS | | INC | CHES | |
|---------------------------------|-------------|-------|-------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| А | 4.25 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.01 | 0.027 | 0.040 | |
| b(1) | 1.20 | 1.73 | 0.047 | 0.068 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.85 | 15.49 | 0.585 | 0.610 | |
| Е | 10.04 | 10.51 | 0.395 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.09 | 6.48 | 0.240 | 0.255 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.35 | 14.02 | 0.526 | 0.552 | |
| L(1) | 3.32 | 3.82 | 0.131 | 0.150 | |
| ØΡ | 3.54 | 3.94 | 0.139 | 0.155 | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | |
| ECN: T13-0724-Rev. O, 14-Oct-13 | | | | | |

DWG: 5471

Note

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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